

Product Specification [产品规格书]:		ISSUED BY: Engineering Dept		
Subject [主题]:		Date Issued	2012/01/10	
	1.80mm Pitch 1800 Series Connector Specification	Date Revised	2017/03/03	

This specification is referred to the 1.80mm series wire to board connector

# 索引【INDEX】

- 1. 适用范围 【Scope】
- 2. 规格与料号 【Spec and Part number】
- 3. 材质与表面处理 【Disposal of Material and surface】
- 4. 额定等级 【Ratings and applicable wires】
- 5. 性能 【 Performance 】
  - 5-1. 电气的性能【Electrical Performance.】
  - 5-2. 机械的性能【Mechanical Performance】
  - 5-3. 环境性能及其它【Environmental Performance and Others】
- 6. 综合插入力及拔出力 【 Insertion/Withdrawal Force 】
- 7. SMT 回流条件 【 SMT Reflow Condition 】



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### 【1.适用范围 Scope】

此种规格包括 1.80mm Pitch 1800 Series 连接器规格说明.

This Specification Covers the 1.80mm Pitch 1800 Series Connector Specification.

## 【2.规格与料号 Spec and Part number】

规格内容	产品料号	产品图示
Specification	Production No.	Picture of Product
端子/Terminal	1800TX-PSN-X	NONE
胶壳/Housing	1800H-02-N0XX 1800H-02X-N0XX	NONE
针座/Wafer	1800WRS-02-XXXX 1800WRS-02X-XXXX	NONE

## 【3.材质与表面处理 Disposal of Material and surface】

15 的 放				
规格内容		材 质	表面处理	
Specification		Materials	Disposal of Surface	
端子/Terminal		磷铜/Phosphor Bronze	50u"Min Ni 、100u"Min Bright Tin	
胶壳/Housing		PA66	UL 94V-0	
Base		High Temperature Plastic	UL 94V-0	
针座/Wafer	PIN	黄铜/Brass	30u"Min Ni 、70u"Min Matte Tin	
	Solder tab	黄铜/Brass	30u"Min Ni 、70u"Min Matte Tin	

<sup>(</sup>上述参数请以工程图为准/Please Refer to the Project drawing for the above Specification)

## 【4. 额定等级 Ratings and applicable wires】

项 目【Item】	规 格【Standard】		
额定电压 Rated Voltage (Max.)	350V	[AC/DC]	
额定电流 Rated Current (Max.)	4.0A	[AC/DC]	
使用温度范围 Ambient temperature Range	-25°C~+85°C		
适用线径 Applicable wire insulation O.D	22~26 AWG Insulation O.D. 1.30mm(Max.)		

<sup>\*</sup>升温时含端子.Including terminal temperature rise.



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#### 【5.性能 PERFORMANCE】

## 5-1. 电气的性能 Electrical Performance.

	项 目 【Item】	条   件 【Test Condition】	规 格 【Requirement】
5-1-1	接触阻抗 Contact Resistance	公母配合,开放电压 20mV 以下,电流 10mA 检测连接器 A~B 区. Mate connectors, measure by dry circuit, 20mV MAX, 10mA. (Based upon EIA-364-06A).	Initial: 10 milliohms Max. After Test: 20 milliohms Max.
5-1-2	绝缘阻抗 Insulation Resistance	公母配合,在相邻端子,端子与地片之间,使用 500V 的直流电,检测连接器. Mate connectors, apply 500V DC between adjacent terminal or ground. (Based upon EIA-364-21B / MIL-STD-202 Method 302 Cond.B)	1000 Megohms Min.
5-1-3	耐电压 Dielectric Strength	公母配合,在相邻端子,端子与地片之间,使用 1700V的交流电 1 分锺,检测连接器. Mate connectors, apply 1700V AC for 1 minute between adjacent terminal or ground. (Based upon EIA-364-20A / MIL-STD-202 Method 301)	不出现中断等情况 No Breakdown and Flashover
5-1-4	触阻抗 Contact resistance on	铆线后之端子,开放电压 20mV 以下,电流 10mA 检测连接器. Crimp the applicable wire on to the terminal measure by dry circuit 20mV MAX, 10mA.	10 milliohms Max.



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### 5-2. 机械的性能 Mechanical Performance.

	项 目				
	【Item】	【Test Condition】	[Requirement]		
5-2-1	插拔力 Insertion & withdraw Force	以每分锺 25.4±3mm 的速率插入和拔出.  Insert and withdraw Connectors at the speed rate of 25.4±3mm/minute.  Socket Header Insertion Withdrawal	参照第 6 项 Refer to paragraph 6		
5-2-2	端子保持力 Terminal/ Housing Retention Force	以每分 25.4±3mm 的速率,将端子从 Housing 内轴向拔出的力量. Apply axial pull out force at the speed rate of 25.4±3mm/minute on the FFC in the housing.	9.8N {1.0kgf} Min.		
5-2-3	Pin 针保持力 Pin Retention Force	以每分 25.4±3mm 的速率,将 PIN 针从 Wafer 内轴向推出的力量. Apply axial push force at the speed rate of 25.4±3mm/minute.	4.9N {0.50kgf} Min.		
5-2-4	端子插入力 Terminal Insertion Force	铆线后之端子插入 Housing 所需最大力量. Insert the crimped terminal into the housing.	9.8N {1.0kgf} Max.		
5-2-5	Lock HSG 卡扣保持 力 Lock Retention Force	以每分 25.4±3mm 的速率,将 HSG 从 Wafer 内轴向拔出的力量. Apply axial push force at the speed rate of 25.4±3mm/minute.	12N {1.20kgf} Min.		

WRITTEN BY:Alan gin	APPROVED BY:Joshua	Sheet: 4 of 7
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	项 目	条件		规	格	
	【Item】	Test Condition	ľ	Require	ement	
		固定铆线后的端子,使电线与端子分离时所需的最小力量.	AWG	22	24	26
		Fix the crimped terminal, apply axial pull	Spec.			
		out force on the wire. (Do not crimp	kgf	5.0	3.0	2.0
5-2-	5 端子压着强度	insulation part).	Min.			
	(Crimped connections)	Contact Wire	Note> As f this specif	<del>-</del>	efine valu	

### 5-3. 环境性能及其它 Environmental Performance and Others.

	项 目	条 件	规	格	
[Item]		[Test Condition]	[Requirement]		
5-3-1	重复插拔 Repeated Insertion/ Withdrawal	以每分锺不超过 10 次的速率,将公母插拔 30次. When mated up to 30 cycles repeatedly by the rate of 10 cycles per minute.	接触阻抗 Contact Resistance	20 milliohms Max.	
5-3-2	温升测试 Temperature Rise	公母对插后,在通过额定电流下,所测定的温度.Carrying rated current load. (UL 1977)	温升测试 Temperature rise	30°C Max.	
	振动测试 Vibration test	振幅: 1.5mm P-P 时间: 10~55~10 HZ in 1 minute	外观 Appearance	无异状 No Damage	
5-3-3		持续时间:每轴向 2 小时 Amplitude: 1.5mm P-P Sweep time: 10~55~10 HZ in 1 minute Duration: 2 hours in each X.Y.Z axials. (Based upon EIA-364-28B/MIL-STD-202 Method 213B Cond.A)	接触阻抗 Contact Resistance	20 milliohms Max.	
			瞬断 Discontinuity	1 micro- second Max.	
5-3-4	冲击测试 Shock test	在X.Y.Z上6个方向上,以490m/s²(50g的力量) 冲击下各 3 回. 490m/s²{50G}, 3 strokes in each X.Y.Z. axes. (Based upon EIA-364-27B/MIL-STD-202 Method 213B Cond.A)	外观 <b>Appearance</b>	无异状 No Damage	
			接触阻抗 Contact Resistance	20 milliohms Max.	
			瞬断 Discontinuity	1 micro- second Max.	
5-3-5	耐热性 Heat Resistance	85±2°C,96 hours.	外观 Appearance	无异状 No Damage	
		(Based upon MIL-STD-202 Method 108A Cond.A)	接触阻抗 Contact Resistance	20 milliohms Max.	

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项 目 【Item】		条   件 【Test Condition】	规 格 【Requirement】		
5-3-6	耐寒性	-25±5°C,96 hours. ( Based upon EIA-364-105)	外观 Appearance 接触阻抗 Contact Resistance	无异状 No Damage 20 milliohms Max.	
	耐湿性 Humidity	温度: 40±2°C 湿度: 90~95%(RH) 持续时间: 96 hours	外观 Appearance 接触阻抗 Contact Resistance	无异状 No Damage 20 milliohms Max.	
5-3-7		Temperature: 40±2°C Relative Humidity: 90~95% Duration: 96 hours	耐电压 Dielectric Strength	Must meet 5-1-3	
		(Based upon EIA-364-31A/MIL-STD-202 Method 103B Cond.B)	绝缘阻抗 Insulation Resistance	500 Megohms Min.	
5-3-8	温度变化 Temperature Cycling	从-25℃持续 30 分锺升至+85℃持续 30 分锺, 循环 5 次.	外观 Appearance	无异状 No Damage	
		5 cycles of: a) -25°C 30 minutes. b) +85°C 30 minutes. (Based upon EIA-364-32B)	接触阻抗 Contact Resistance	20 milliohms Max.	
5-3-9	盐水喷雾 Salt Spray	在温度 35±2℃,盐水浓度 5±1%下,盐水喷雾 48±1 小时. 48±1 hours exposure to a salt spray from	外观 Appearance	无异状 No Damage	
		the 5±1% solution at 35±2°C. (Based upon EIA-364-26A/MIL-STD-202 Method 101D Cond.B).	接触阻抗 Contact Resistance	20 milliohms Max.	
5-3-10	焊锡附着性 Solder- ability	焊接时间: 3±0.5 秒. 焊接温度: 245±3℃. Soldering Time: 3±0.5second. Solder Temperature: 245±3℃. (Based upon EIA-364-52)	Solder Wetting	浸渍面积需 95%以上 95% of immersed area must show no voids, pin holes.	



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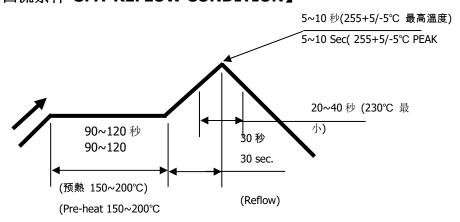
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5-3-11	焊锡耐热性 Solder- Resistance	焊接时间: 5~10 秒. 焊接温度: 255+5/-5℃. Soldering time:5~10 sec solder.	外观 Appearance	无异状 No Damage
5-5-11		Temperature: 255+5/-5°C. (Based upon EIA-364-56A)		

#### 【6.综合插入力及拔出力 INSERTION/WITHDRAWAL FORCE】 < Connector mating force >

PIN 数 No. of CKT	初次插入力(最大值) First Insertion (kgf Max.)	30 次拔出力(最小值) 30 <sup>th</sup> Withdrawal (kgf Min.)	PIN 数 No. of CKT	初次插入力(最大值) First Insertion (kgf Max.)	30 次拔出力(最小值) 30 <sup>th</sup> Withdrawal (kgf Min.)
2	2.00	0.20			

注: 以上插拔次数为 30 次 Note: Insertion and Withdrawal for 30 Cycles

#### 【7. SMT 回流条件 SMT REFLOW CONDITION】



温度条件曲线图/ 基板上温度

#### TEMPERATURE CONDITION GRAPH/ (TEMPERATURE ON BOARD PATTERN SIDE)

注记: 由于 P.C 板等焊接装置改变条件,所以请预先用自己的装置检查回流焊的条件.

Notes: Please check the reflow soldering condition by your own devices beforehand. Because the condition changes by the soldering devices, P.C. boards, and so on.

WRITTEN BY: Alan qin APPROVED BY: Joshua Sheet: 7 of 7